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David V. Carlson Telephone: (206) 694-4828 August 31, 2007 davec@SeedIP.com Facsimile Transmission To: PCT Operations Seed intellectual Property Law Group PLLC Fax No: (571) 273-3201 Phone No: U.S. Patent Application No. 10/580,991 Re: Seed IP Ref: 890050.542USPC No. of Pages: 6 (including this page) If you do not receive all pages, please call Laura Shockey at (206) 622-4900 or fax our office. Please Reply Please Confirm **ASAP** For Review address 701 Fifth Avenue Urgent Receipt Suite 5400 Seattle, WA 98104 telephone 206.622.4900 facsimile 206.682.6031 Comments: website SeedIP.com

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Request for Corrected Filing Receipt

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PATENT

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Office on the date shown below:

Date

Jama C- Sho Cheg Laura C. Shockey

PATENT COOPERATION TREATY

Applicants

Shigeki Satou et al.

Application No.

10/580,991

Filed

May 26, 2006

For

CONDUCTIVE PASTE FOR AN ELECTRODE LAYER OF A MULTI-LAYERED CERAMIC ELECTRONIC COMPONENT AND A METHOD FOR MANUFACTURING A MULTI-LAYERED UNIT FOR A MULTI-LAYERED CERAMIC

ELECTRONIC COMPONENT

Art Unit

1734

Docket No.

890050.542USPC

Date

August 31, 2007

Mail Stop PCT Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents:

Attached is a copy of the official Filing Receipt received from the PTO in the above-identified application, for which issuance of a corrected Filing Receipt is respectfully requested.

There is an error with respect to the following data, which was not entered. There is an error in the Foreign Applications, which should read:

JAPAN 2003-396990 11-27-03

The corrections to be made have been marked on the attached copy of the Filing

Receipt.

Respectfully submitted,

Seed Intellectual Property Law Group PLLC

David V. Carlson

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Enclosure:

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FILING RECEIPT

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CONFIRMATION NO. 7056

500 SEED INTELLECTUAL PROPERTY LAW GROUP PLLC 701 FIFTH AVE **SUITE 5400** SEATTLE, WA 98104

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FEB 1 2 2007

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If Alexandria va 22313-1450. Flease provide a copy of this Filling Receipt with the changes noted discountry you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filling Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filling Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Shigeki Satou, Tokyo, JAPAN; Takeshi Nomura, Tokyo, JAPAN;

Assignment For Published Patent Application

TDK Corporation, Tokyo, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 500.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/17397 11/24/2004

Foreign Applications

Japan-2003-396990 11-27-03

If Required, Foreign Filing License Granted: 02/02/2007

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, Is US10/580,991

Projected Publication Date: 05/17/2007

ENTERED IN DOCKET

Non-Publication Request: No

Early Publication Request: No

Page 2 of 3

Title

Conductive paste for an electrode layer of a multi-layered ceramic electronic component and a method for manufacturing a multi-layered unit for a multi-layered ceramic electronic component

Preliminary Class

156

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